

TrenchT2[™] Power MOSFET

Symbol

V_{DSS}

 V_{DGR}

 $\mathbf{V}_{\mathrm{GSS}}$

 V_{GSM}

 \mathbf{I}_{D25}

I_{DM}

I

E_{AS}

 \mathbf{P}_{D}

 T_{J}

 \mathbf{T}_{JM}

T_{stg}

 T_L

M,

 $T_{\underline{s_{OLD}}}$

Weight

IXTA140N12T2 IXTP140N12T2

 $V_{DSS} = 120V$ $I_{D25} = 140A$ $R_{DS(on)} \le 10m\Omega$

N-Channel Enhancement Mode Avalanche Rated Fast Intrinsic Rectifier

Test Conditions

Continuous Transient

 $T_{c} = 25^{\circ}C$

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TO-263

TO-220

Plastic Body for 10s

Mounting Torque (TO-220)

T, = 25°C to 175°C

 $T_J = 25^{\circ}C$ to 175°C, $R_{gs} = 1M\Omega$

 $T_{\rm C} = 25^{\circ}$ C, Pulse Width Limited by $T_{\rm IM}$

Maximum Lead Temperature for Soldering



Α

Α

Α

J

W

°C

°C

٥С

°С

٥С

g

g

Nm/lb.in.

Maximum Ratings

120

120

±20

±30

140

350

70

1.3

577

175

300

260

2.5

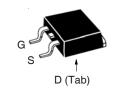
3.0

1.13 / 10

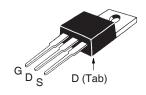
-55 ... +175

-55 ... +175

TO-263AA (IXTA)



TO-220AB (IXTP)



G = Gate	D	= Drain
S = Source	Tab	= Drain

Features

- International Standard Packages
- 175°C Operating Temperature
- Avalanche Rated
- Low R_{DS(on)}
- Fast Intrinsic Rectifier
- High Current Handling Capability

Symbol $(T_J = 25^{\circ}C)$	Test Conditions Unless Otherwise Specified)	Charac Min.	teristic Typ.	Value Max	
BV _{DSS}	$V_{GS} = 0V, I_{D} = 250\mu A$	120			V
V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250\mu A$	2.5		4.5	V
I _{GSS}	$V_{GS} = \pm 20V, V_{DS} = 0V$			±200	nA
I _{DSS}	$V_{DS} = V_{DSS}, V_{GS} = 0V$			10	μΑ
	$T_J = 150$ °C			500	μΑ
R _{DS(on)}	$V_{GS} = 10V, I_{D} = 0.5 \cdot I_{D25}, Notes 1, 2$		8	10	mΩ

Advantages

- Easy to Mount
- Space Savings
- High Power Density

Applications

- Synchronous Rectification
- DC/DC Converters and Off-Line UPS
- Primary- Side Switch
- High Current Switching Applications



•	SymbolTest ConditionsChara $T_J = 25$ °C, Unless Otherwise Specified)Min.			acteristic Values Typ. Max.		
g _{fs}		$V_{DS} = 10V, I_{D} = 0.5 \cdot I_{D25}, \text{ Note 1}$	66	110	S	
C _{iss})			9700	pF	
Coss	}	$V_{GS} = 0V, V_{DS} = 25V, f = 1MHz$		850	pF	
C _{rss})			58	pF	
t _{d(on)}	١	Resistive Switching Times		27	ns	
t _r		$V_{GS} = 10V, V_{DS} = 0.5 \cdot V_{DSS}, I_{D} = 0.5 \cdot I_{D25}$		30	ns	
t _{d(off)}		$R_{G} = 2\Omega$ (External)		39	ns	
t _f	J			17	ns	
$\mathbf{Q}_{g(on)}$)			174	nC	
Q _{gs}	}	$V_{GS} = 10V$, $V_{DS} = 0.5 \cdot V_{DSS}$, $I_{D} = 0.5 \cdot I_{D25}$		52	nC	
\mathbf{Q}_{gd}	J			40	nC	
R _{thJC}					0.26 °C/W	
R _{thCH}		TO-220		0.50	°C/W	

Source-Drain Diode

Symbo	ol Test Conditions Ch	aracteristi	c Values	
$(T_J = 2)$	5°C, Unless Otherwise Specified) Mir	ı. Typ.	Max.	
Is	$V_{GS} = 0V$		140	Α
I _{SM}	Repetitive, Pulse Width Limited by $T_{_{JM}}$		560	Α
V _{SD}	$I_F = I_S$, $V_{GS} = 0V$, Note 1		1.4	V
t _{rr}	$I_F = 0.5 \cdot I_{D25}, V_{GS} = 0V$	65		ns
I _{RM}	-di/dt = 100A/μs	13		Α
\mathbf{Q}_{RM}	$V_{R} = 60V$	430		nC

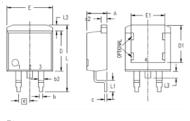
Notes: 1. Pulse test, $t \le 300\mu s$, duty cycle, $d \le 2\%$.

2. On through-hole packages, $R_{\mathrm{DS(on)}}$ Kelvin test contact location must be 5mm or less from the package body.

ADVANCE TECHNICAL INFORMATION

The product presented herein is under development. The Technical Specifications offered are derived from a subjective evaluation of the design, based upon prior knowledge and experience, and constitute a "considered reflection" of the anticipated result. IXYS reserves the right to change limits, test conditions, and dimensions without notice.

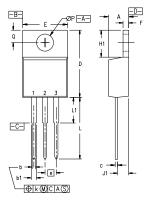
TO-263 Outline



Pins: 1 - Gate 2,4 - Drain 3 - Source

SYM	INCHES		MILLIMETERS	
2114	MIN	MAX	MIN	MAX
Α	.160	.190	4.06	4.83
A1	.080	.110	2.03	2.79
b	.020	.039	0.51	0.99
b2	.045	.055	1.14	1.40
С	.016	.029	0.40	0.74
c2	.045	.055	1.14	1.40
D	.340	.380	8.64	9.65
D1	.315	.350	8.00	8.89
E	.380	.410	9.65	10.41
E1	.245	.320	6.22	8.13
е	.100 BSC		2.54 BSC	
L	.575	.625	14.61	15.88
L1	.090	.110	2.29	2.79
L2	.040	.055	1.02	1.40
L3	.050	.070	1.27	1.78
L4	0	.005	0	0.13

TO-220 Outline



Pins: 1 - Gate 2 - Drain 3 - Source

MYZ	INCHES		MILLIMETERS		
2114	MIN	MAX	MIN	MAX	
Α	.170	.190	4.32	4.83	
b	.025	.040	0.64	1.02	
b1	.045	.065	1.15	1.65	
С	.014	.022	0.35	0.56	
D	.580	.630	14.73	16.00	
E	.390	.420	9.91	10.66	
е	.100 BSC		2.54 BSC		
F	.045	.055	1.14	1.40	
H1	.230	.270	5.85	6.85	
J1	.090	.110	2.29	2.79	
k	0	.015	0	0.38	
L	.500	.550	12.70	13.97	
L1	.110	.230	2.79	5.84	
ØΡ	.139	.161	3.53	4.08	
Q	.100	.125	2.54	3.18	

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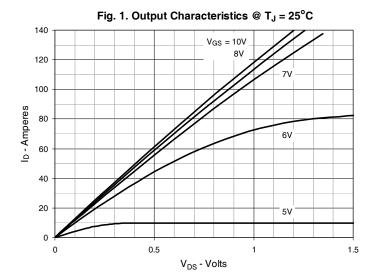
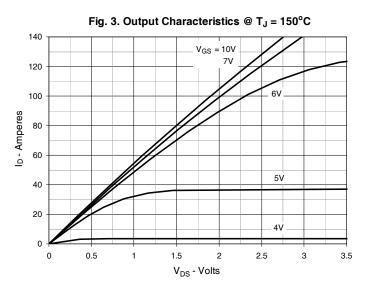
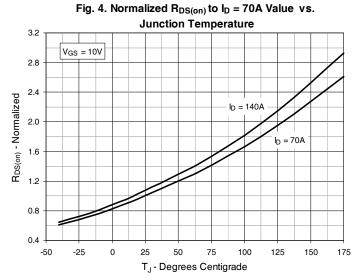
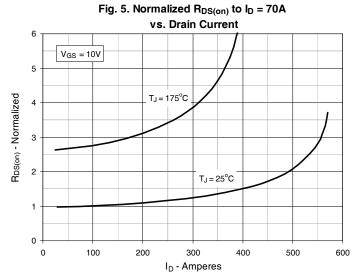
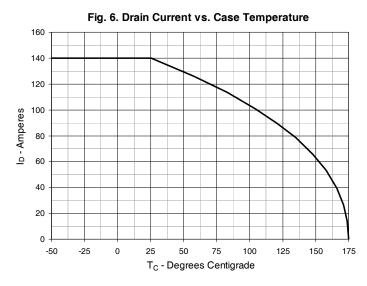


Fig. 2. Extended Output Characteristics @ T_J = 25°C 600 $V_{GS} = 15V$ 10V 500 8V 400 300 200 6V 100 5V 0 0 5 10 15 20 25 30 V_{DS} - Volts

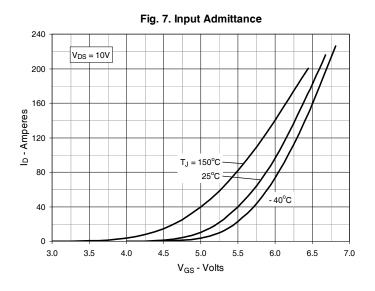


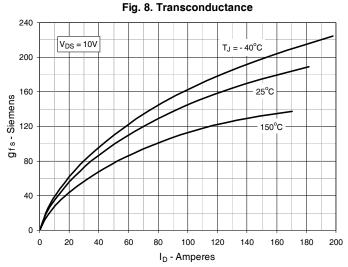


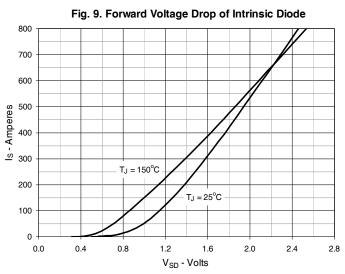


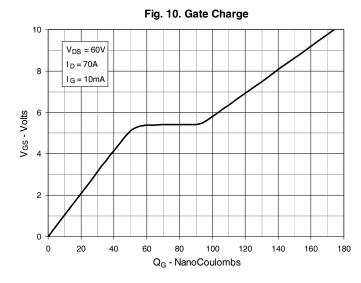


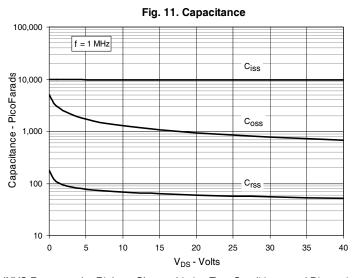


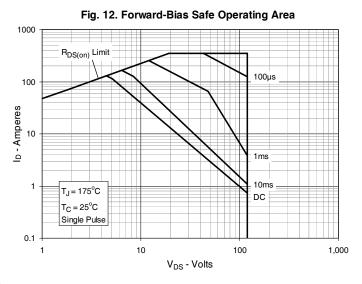






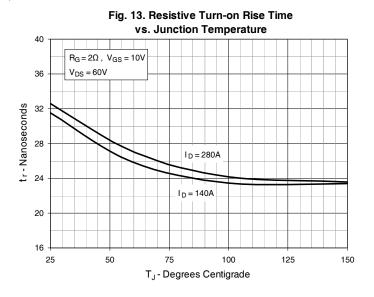


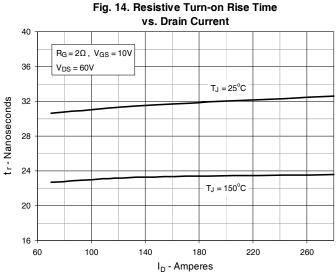


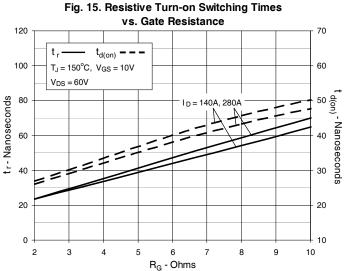


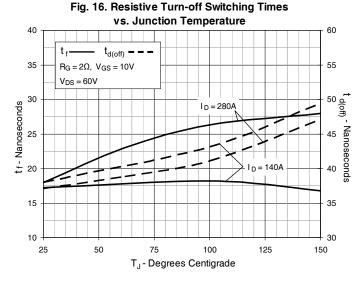
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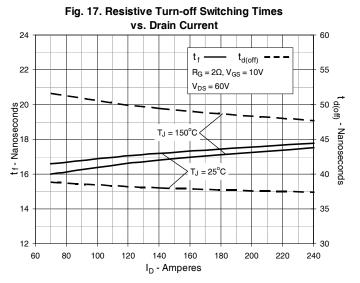


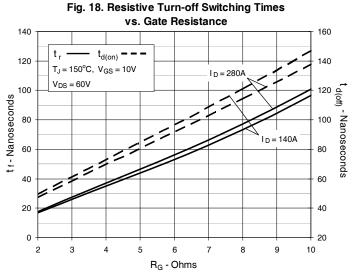














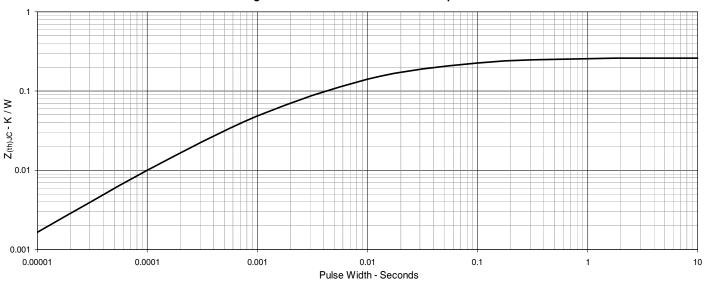


Fig. 19. Maximum Transient Thermal Impedance

